

FEATURES

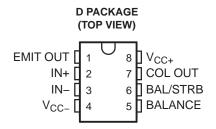
Controlled Baseline

 One Assembly/Test Site, One Fabrication Site

- Extended Temperature Performance of -55°C to 125°C
- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product Change Notification
- Qualification Pedigree (1)
- Fast Response Times
- Strobe Capability
- (1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold-compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

DESCRIPTION/ORDERING INFORMATION

- Maximum Input Bias Current . . . 300 nA
- Maximum Input Offset Current . . . 70 nA
- Can Operate From Single 5-V Supply



The LM211-EP is a single high-speed voltage comparator. This device is designed to operate from a wide range of power-supply voltages, including \pm 15-V supplies for operational amplifiers and 5-V supplies for logic systems. The output levels are compatible with most TTL and MOS circuits. This comparator is capable of driving lamps or relays and switching voltages up to 50 V at 50 mA. All inputs and outputs can be isolated from system ground. The outputs can drive loads referenced to ground, V_{CC+} or V_{CC-}. Offset balancing and strobe capabilities are available, and the outputs can be wired-OR connected. If the strobe is low, the output is in the off state, regardless of the differential input.

ORDERING INFORMATION

T _A	V _{IO} max AT 25°C	PAC	(AGE ⁽¹⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING		
–40°C to 125°C	3 mV	SOIC – D	Tape and reel	LM211QDREP	LM211E		
–55°C to 125°C	3 mV	SOIC – D	Tape and reel	LM211MDREP	LM211M		

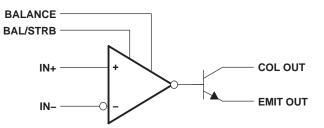
(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



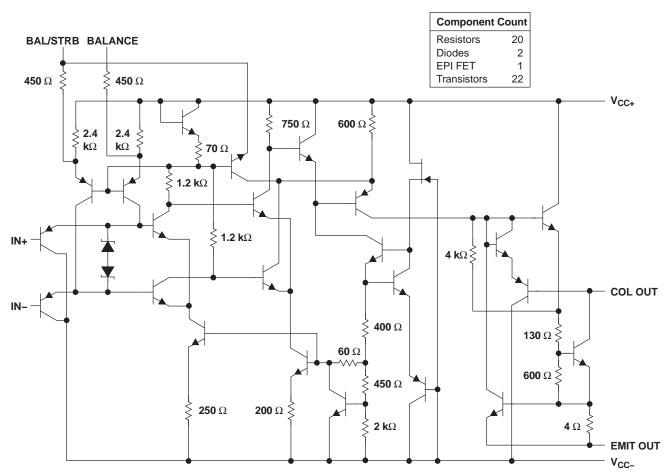
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



FUNCTIONAL BLOCK DIAGRAM







All resistor values shown are nominal.

Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V _{CC+}			18	
V _{CC-}	Supply voltage ⁽²⁾		-18	V
V_{CC-} $V_{CC+} - V_{CC-}$			36	
V _{ID}	Differential input voltage ⁽³⁾		±30	V
VI	Input voltage, either input ⁽²⁾⁽⁴⁾		±15	V
	Voltage from emitter output to V_{CC-}		30	V
	Voltage from collector output to V _{CC-}		50	V
	Duration of output short circuit ⁽⁵⁾		10	S
TJ	Junction temperature		148	°C
θ_{JA}	Package thermal impedance ⁽⁶⁾		97	°C/W
	Lead temperature 1,6 mm (1/16 in) from case for 10 s		260	°C
T _{stg}	Storage temperature range ⁽⁷⁾	-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltage values, unless otherwise noted, are with respect to the midpoint between V_{CC+} and V_{CC-}.

(3) Differential voltages are at IN+ with respect to IN-.

(4) The magnitude of the input voltage must never exceed the magnitude of the supply voltage or ±15 V, whichever is less.

(5) The output may be shorted to ground or either power supply.

(6) The package thermal impedance is calculated in accordance with JESD 51-7.

(7) Long-term high-temperature storage and/or extended use at maximum recommended operating conditions may result in a reduction of overall device life. See http://www.ti.com/ep_quality for additional information on enhanced plastic packaging.

Recommended Operating Conditions

		MIN	MAX	UNIT
$V_{CC+} - V_{CC-}$	Supply voltage	3.5	30	V
VI	Input voltage ($ V_{CC+} \le 15 \text{ V}$)	V _{CC-} + 0.5	V _{CC+} – 1.5	V
T _A	Operating free-air temperature range for Q temp	-40	125	°C
T _A	Operating free-air temperature range for M temp	-55	125	°C

LM211-EP DIFFERENTIAL COMPARATOR WITH STROBES

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Electrical Characteristics

at specified free-air temperatures of Q and M temp ranges, $V_{CC+} = \pm 15$ V (unless otherwise noted)

	PARAMETER	TEST CO	NDITIONS	T _A ⁽¹⁾	MIN	TYP ⁽²⁾	MAX	UNIT	
	la suit effect usite se (3)	Hanne (3)		25°C		0.7	3		
V _{IO}	Input offset voltage ⁽³⁾			Full range			4	mV	
	Innut offect ourrent(3)			25°C		4	10	~^	
IIO	Input offset current ⁽³⁾			Full range			20	nA	
	lanut biog ourrent			25°C		75	100		
I _{IB} Input b	Input bias current	$V_{O} = 1 V \text{ to } 14 V$	Full range			150	nA		
I _{IL(S)}	Low-level strobe current ⁽⁴⁾	$V_{(strobe)} = 0.3 V,$	$V_{ID} \leq -10 \text{ mV}$	25°C		-3		mA	
VICR	Common-mode input voltage range			Full range	13 to -14.5	13.8 to -14.7		V	
A _{VD}	Large-signal differential voltage amplification	$V_{O} = 5 V \text{ to } 35 V,$	$R_L = 1 \ k\Omega$	25°C	40	200		V/mV	
	High-level (collector)	$I_{(strobe)} = -3 \text{ mA},$ $V_{ID} = 5 \text{ mV}$	V _{OH} = 35 V,	25°C		0.2	10	nA	
I _{OH}	output leakage current	$V_{ID} = 5 \text{ mV}$		Full range			0.5	μA	
		I _{OL} = 50 mA,	$V_{ID} = -5 \text{ mV}$	25°C		0.75	1.5		
	Low-level (collector-to-emitter) output voltage	V _{CC+} = 4.5 V, I _{OL} = 8 mA,	V _{CC-} = 0, V _{ID} = -6 mV	Full range		0.23	0.4	.4 V	
I _{CC+}	Supply current from V_{CC+} , output low	$V_{ID} = -10 \text{ mV},$	No load	25°C		5.1	6	mA	
I _{CC-}	Supply current from V _{CC-} , output high	V _{ID} = 10 mV,	No load	25°C		-4.1	-5	mA	

(1) Unless otherwise noted, all characteristics are measured with BALANCE and BAL/STRB open and EMIT OUT grounded. Full range is -40°C to 125°C for Q temp and -55°C to 125°C for M temp.

(2) All typical values are at $T_A = 25^{\circ}C$. (3) The offset voltages and offset currents given are the maximum values required to drive the collector output up to 14 V or down to 1 V with a pullup resistor of 7.5 kΩ to V_{CC+}. These parameters actually define an error band and take into account the worst-case effects of voltage gain and input impedance.

(4) The strobe should not be shorted to ground; it should be current driven at -3 mA to -5 mA (see Figure 13 and Figure 27).

Switching Characteristics

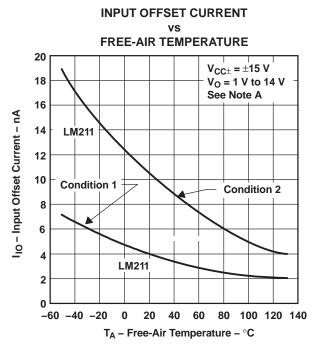
 $V_{CC+} = \pm 15 \text{ V}, \text{ T}_{A} = 25^{\circ}\text{C}$

PARAMETER		TEST CONDITIONS	TYP	UNIT
Response time, low-to-high-level output	R_C = 500 Ω to 5 V,	$C_{L} = 5 \text{ pF}^{(1)}$	115	ns
Response time, high-to-low-level output	R_C = 500 Ω to 5 V,	$C_{L} = 5 pF^{(1)}$	165	ns

(1) The response time specified is for a 100-mV input step with 5-mV overdrive and is the interval between the input step function and the instant when the output crosses 1.4 V.

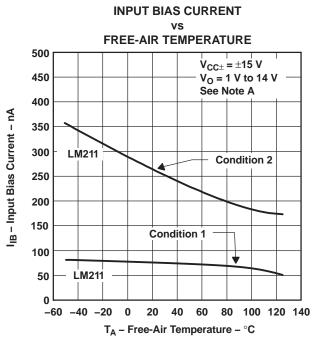
TYPICAL CHARACTERISTICS

Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



NOTE A: Condition 1 is with BALANCE and BAL/STRB open. Condition 2 is with BALANCE and BAL/STRB connected to $V_{\text{CC+}}$

Figure 1.



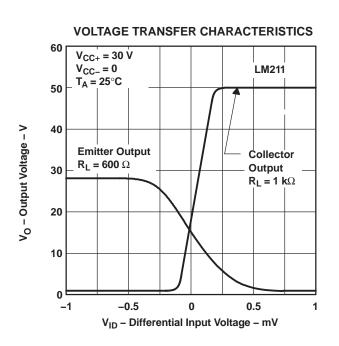
NOTE A: Condition 1 is with BALANCE and BAL/STRB open. Condition 2 is with BALANCE and BAL/STRB connected to $V_{\rm CC+}.$

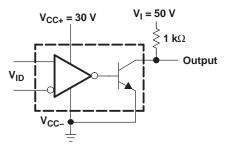
Figure 2.



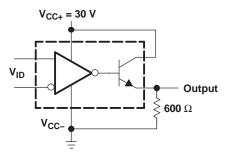
TYPICAL CHARACTERISTICS (continued)

Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.





COLLECTOR OUTPUT TRANSFER CHARACTERISTIC TEST CIRCUIT FOR FIGURE 3



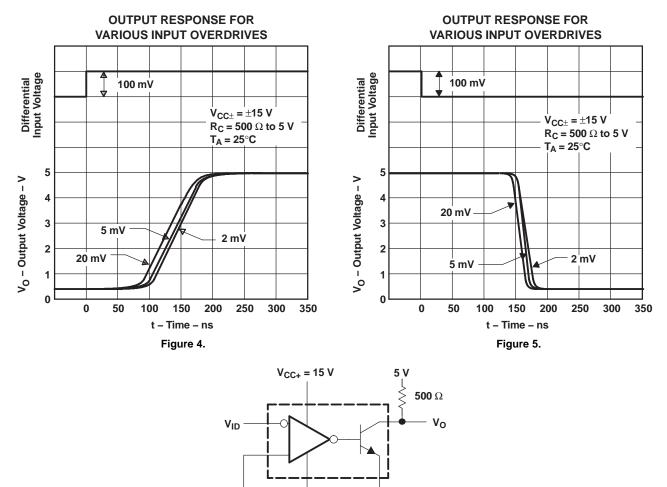
EMITTER OUTPUT TRANSFER CHARACTERISTIC TEST CIRCUIT FOR FIGURE 3

Figure 3.



TYPICAL CHARACTERISTICS (continued)

Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



TEST CIRCUIT FOR FIGURES 4 AND 5

 $V_{CC-} = -15 V$

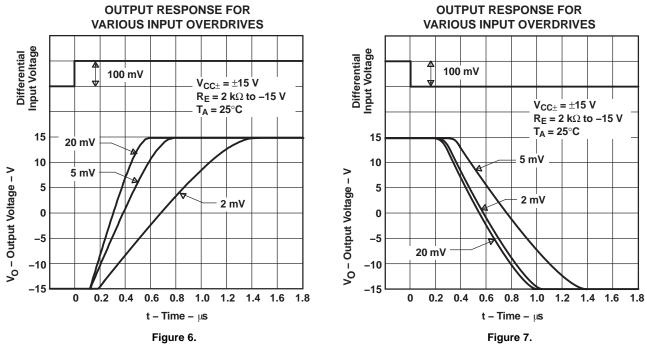
LM211-EP DIFFERENTIAL COMPARATOR WITH STROBES

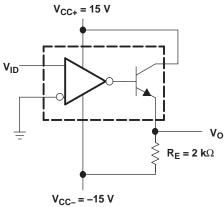


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TYPICAL CHARACTERISTICS (continued)

Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.





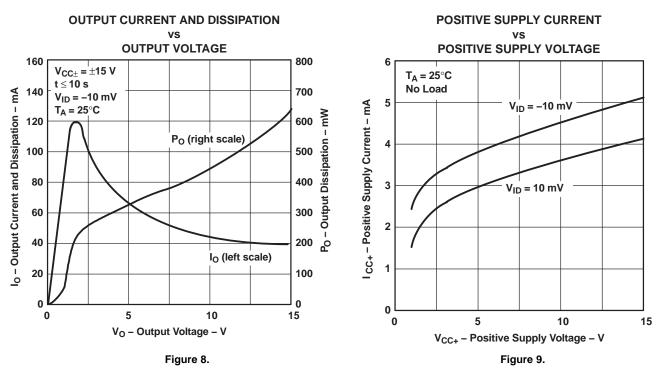


LM211-EP DIFFERENTIAL COMPARATOR WITH STROBES

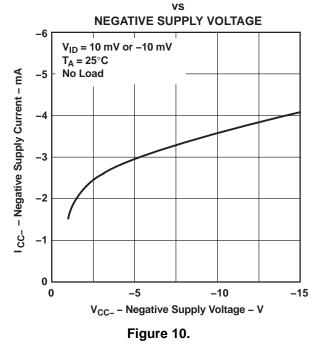
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TYPICAL CHARACTERISTICS (continued)

Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



NEGATIVE SUPPLY CURRENT



APPLICATION INFORMATION

Figure 11 through Figure 29 show various applications for the LM211-EP comparator.

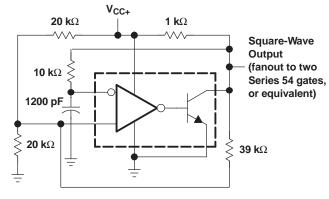
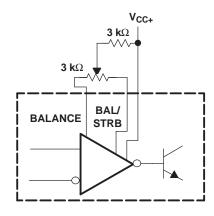


Figure 11. 100-kHz Free-Running Multivibrator



NOTE: If offset balancing is not used, the BALANCE and BAL/STRB pins should be shorted together.

Figure 12. Offset Balancing

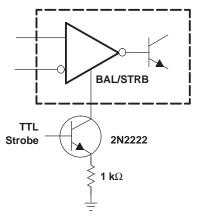
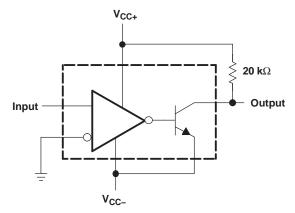
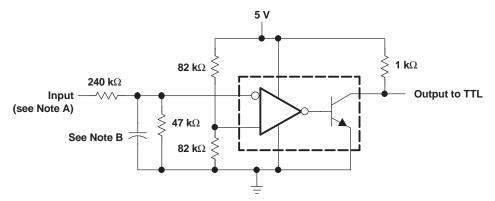


Figure 13. Strobing

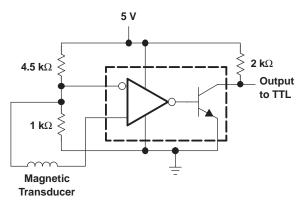




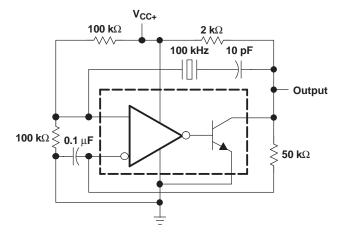


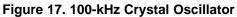
- A. Resistor values shown are for a 0-to-30-V logic swing and a 15-V threshold.
- B. May be added to control speed and reduce susceptibility to noise spikes

Figure 15. TTL Interface With High-Level Logic









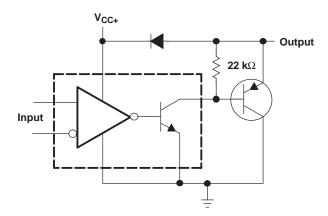
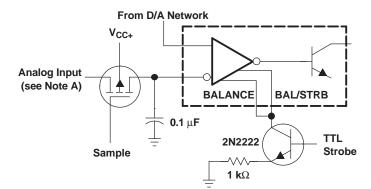


Figure 18. Comparator and Solenoid Driver



A. Typical input current is 50 pA with inputs strobed off.



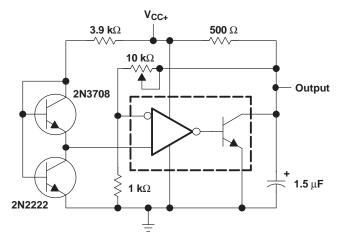
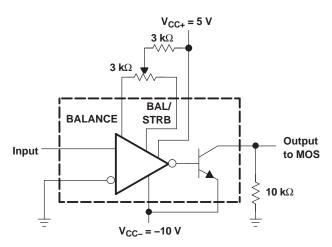
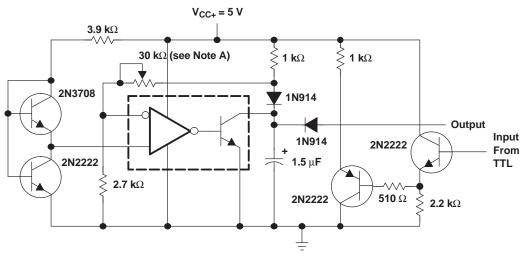


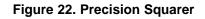
Figure 20. Low-Voltage Adjustable Reference Supply







A. Adjust to set clamp level



APPLICATION INFORMATION (continued)

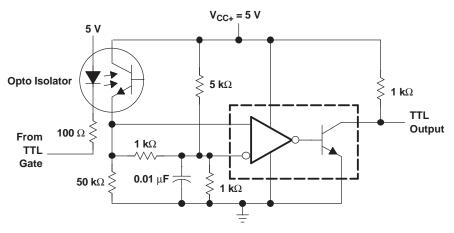
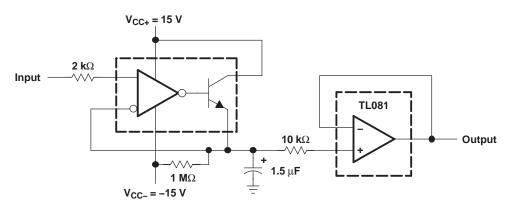
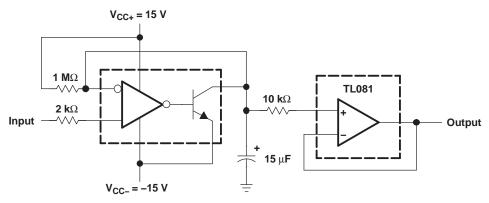
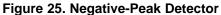


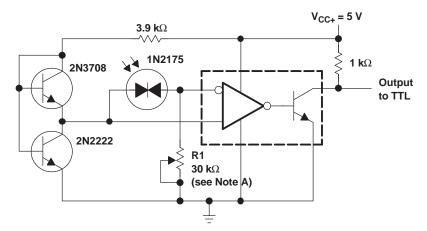
Figure 23. Digital Transmission Isolator











A. R1 sets the comparison level. At comparison, the photodiode has less than 5 mV across it, decreasing dark current by an order of magnitude.

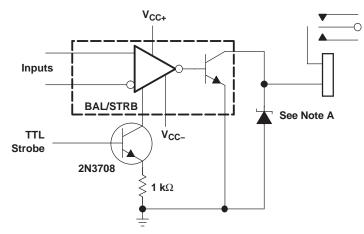


Figure 26. Precision Photodiode Comparator

A. Transient voltage and inductive kickback protection

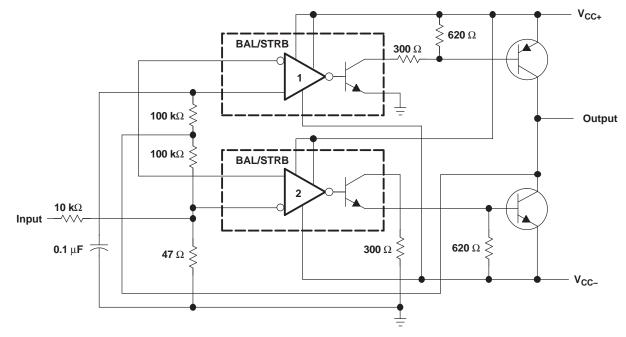
Figure 27. Relay Driver With Strobe

LM211-EP **DIFFERENTIAL COMPARATOR WITH STROBES**



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APPLICATION INFORMATION (continued)





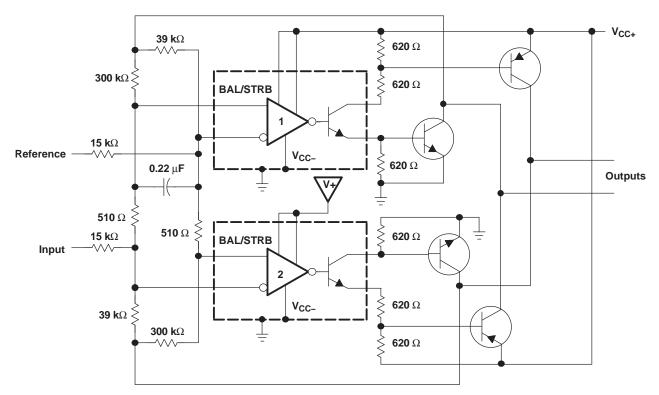


Figure 29. Switching Power Amplifiers



PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
LM211MDREP	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-55 to 125	LM211M	Samples
LM211QDREP	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM211E	Samples
V62/03638-01XE	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	LM211E	Samples
V62/03638-02XE	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-55 to 125	LM211M	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF LM211-EP :

Catalog: LM211

• Automotive: LM211-Q1

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects

PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*Al	dimensions are nominal												
	Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	LM211MDREP	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
	LM211QDREP	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

TEXAS INSTRUMENTS

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PACKAGE MATERIALS INFORMATION

25-Sep-2019



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM211MDREP	SOIC	D	8	2500	367.0	367.0	35.0
LM211QDREP	SOIC	D	8	2500	367.0	367.0	35.0

D0008A



PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.

- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



D0008A

EXAMPLE BOARD LAYOUT

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



D0008A

EXAMPLE STENCIL DESIGN

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.



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